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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Features

- 0805 1.1mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S85AT series is a popular low profile 0805 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

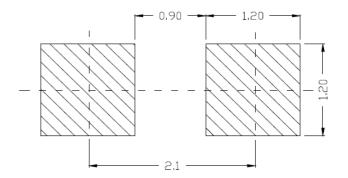


Figure 1. IN-S85AT Solder Pattern

Package Dimensions in mm

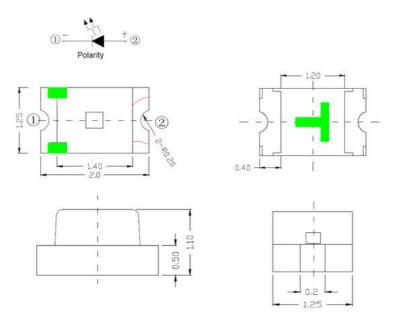


Figure 2. IN-S85AT Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	T _{ST} (°C)				
IN-S85ATYG	Yellow Green										
IN-S85ATY	Yellow	75	25	25	25	25	70				
IN-S85ATA	Amber	75	25	70			-40°C~+90°C				
IN-S85ATR	Red				5	-30°C~+85°C					
IN-S85AT5B	Blue										
IN-S85ATG	Green	75	25	100							
IN-S85AT5UW	White										

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



Electrical Characteristics $T_A = 25C$ (Note 1)

D	Emission		V _F (V)		λ(nm)			Viewing Angel	I* _V (mcd)
Product	Color	I _F (mA)	min	max	λ	λР	Δλ	2 <i>\theta</i> 1/2	typ.
IN-S85ATYG	Yellow Green	20	1.8	2.6	572	576	15	120	45
IN-S85ATY	Yellow	20	1.8	2.6	592	594	15	120	115
IN-S85ATA	Amber	20	1.8	2.6	605	610	20	120	80
IN-S85ATR	Red	20	1.8	2.6	625	630	20	120	140
IN-S85AT5B	Blue	5	2.6	3.4	470	473	30	120	80
IN-S85ATG	Green	20	2.8	3.6	520	528	35	120	600
IN-S85AT5UW	White	5	2.6	3.4	X=0.29 Y=0.29	-	-	120	180

Notes

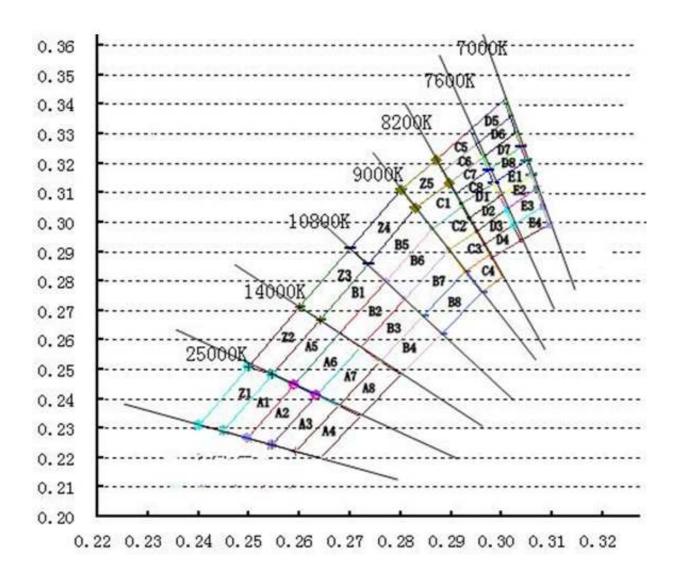
^{1.} Performance guaranteed only under conditions listed in above tables.



Chromaticity Bin (for White only)

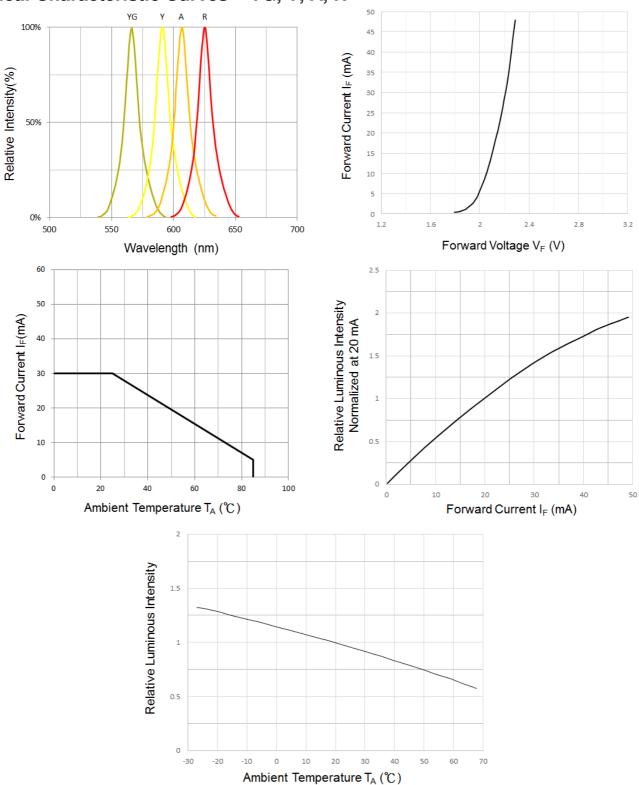
Bin Code	CIE-X	CIE-Y									
	0. 2545	0. 2480		0. 2640	0. 2670		0. 2830	0.3050		0. 2920	0. 3060
A5	0. 2589	0. 2445	B1	0. 2680	0. 2623	C1	0. 2863	0. 2978	D1	0. 2935	0. 3015
l no	0. 2680	0. 2623	DI	0. 2772	0. 2800		0. 2923	0.3052	D1	0. 2997	0. 3088
	0. 2640	0. 2670		0. 2735	0. 2860		0. 2895	0.3134		0. 2984	0. 3133
	0. 2589	0. 2445		0. 2720	0. 2575		0. 2863	0. 2978		0. 2935	0. 3015
A6	0. 2633	0. 2410	B2	0.2680	0. 2623	C2	0. 2895	0. 2905	D2	0. 2950	0. 2970
, no	0.2720	0. 2575	D2	0. 2772	0. 2800	C2	0.2950	0. 2970	D2	0.3009	0. 3042
	0.2680	0. 2623		0. 2808	0. 2740		0. 2923	0.3052		0. 2997	0. 3088
	0. 2677	0. 2375		0. 2720	0. 2575		0. 2895	0. 2905		0. 2950	0. 2970
A7	0. 2633	0. 2410	В3	0. 2760	0. 2528	C3	0. 2928	0. 2833	D3	0. 2965	0. 2925
l n	0. 2720	0. 2575	БЭ	0. 2844	0. 2680	(3	0. 2977	0. 2891	D3	0.3023	0. 2990
	0. 2760	0. 2528		0. 2808	0. 2740		0.2950	0. 2970		0.3009	0. 3042
	0. 2720	0. 2340		0. 2760	0. 2528		0. 2928	0. 2833		0. 2965	0. 2925
A8	0. 2677	0. 2375	B4	0. 2844	0. 2680	C4	0. 2977	0. 2891	D4	0. 2980	0. 2880
l vo	0. 2760	0. 2528	D4	0. 2880	0. 2620	C4	0.3003	0. 2812		0.3037	0. 2937
	0. 2800	0. 2480		0. 2800	0. 2480		0.2960	0.2760		0. 3023	0. 2990
	0. 2984	0. 3133		0. 2735	0. 2860		0. 2883	0.3172		0. 2937	0. 3312
P1	0. 2997	0.3088	D.	0. 2772	0. 2800	05	0. 2870	0.3210	D5	0. 2950	0. 3266
E1	0.3058	0.3160	B5	0. 2863	0. 2978	C5	0. 2937	0.3312		0.3017	0. 3360
	0. 3048	0. 3207		0. 2830	0.3050		0. 2950	0.3266		0.3005	0. 3415
	0. 2997	0. 3088		0. 2772	0. 2800		0.2883	0.3172		0. 2950	0. 3266
FO	0.3009	0. 3042	D.C.	0. 2808	0. 2740	000	0. 2950	0.3266	D.C.	0. 2962	0. 3220
E2	0. 3068	0. 3113	В6	0. 2895	0. 2905	C6	0. 2962	0. 3220	D6	0. 3028	0. 3304
	0.3058	0.3160		0. 2863	0. 2978		0. 2895	0.3134		0.3017	0. 3360
	0.3009	0. 3042		0. 2808	0. 2740		0. 2895	0.3134		0. 2962	0. 3220
	0. 3023	0. 2990	D	0. 2844	0. 2680	0.5	0. 2908	0.3097		0. 2973	0. 3177
E3	0. 3081	0. 3053	В7	0. 2928	0. 2833	C7	0. 2973	0.3177	D7	0.3038	0. 3256
	0.3068	0. 3113		0. 2895	0. 2905		0. 2962	0.3220		0.3028	0. 3304
	0. 3023	0. 2990		0. 2844	0. 2680		0. 2908	0.3097		0. 2973	0. 3177
P.4	0.3037	0. 2937	DO.	0. 2928	0. 2833	- 00	0.2920	0.3060	DO.	0. 2984	0. 3133
E4	0.3093	0. 2993	B8	0. 2960	0. 2760	C8	0. 2984	0.3133	D8	0.3048	0. 3207
	0.3081	0. 3053		0. 2880	0. 2620		0. 2973	0.3177		0. 3038	0. 3256
	0. 25	0. 251		0.26	0. 271		0. 27	0. 291		0. 28	0.311
70	0. 26	0. 271	70	0.27	0. 291	7.4	0. 28	0.311	75	0. 2871	0.321
Z2	0. 264	0. 267	Z3	0. 2735	0. 286	Z4	0. 283	0.305	Z5	0. 2895	0.3134
	0. 2545	0.248		0. 264	0. 267		0. 2735	0. 286		0. 283	0.305
	0.2497	0. 2267		0. 2497	0. 2267		0. 2593	0. 2223		0.2640	0. 2200
A.1	0. 245	0. 229	4.0	0. 2589	0. 2445	4.9	0. 2677	0. 2375		0. 2593	0. 2223
A1	0. 2545	0. 248	A2	0. 2633	0. 241	A3	0. 2633	0.2410	A4	0. 2677	0. 2375
	0. 2589	0. 2445		0. 2545	0. 2245		0. 2545	0. 2245		0. 2720	0. 2340
	0. 24	0. 231									
	0. 25	0. 251									
Z1	0. 2545	0. 248									
	0. 245	0. 2291									
	0.240	0. 2231									





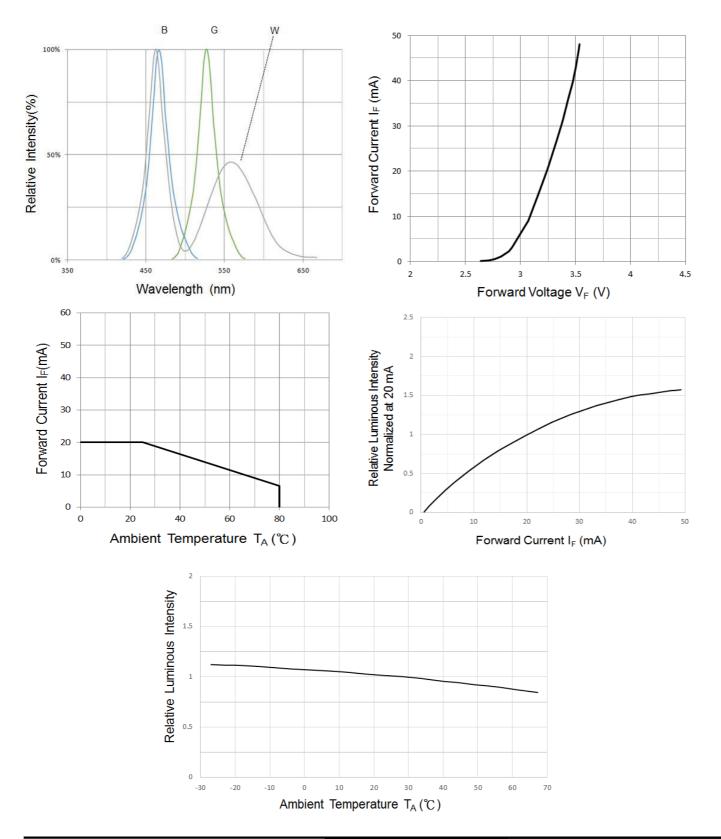


Typical Characteristic Curves – YG, Y, A, R



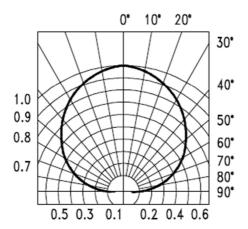


Typical Characteristic Curves - B, G, W





Typical Characteristic Curves – Radiation Pattern

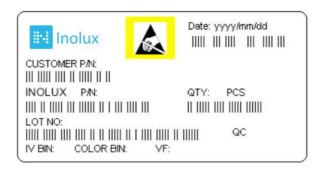


Ordering Information

Product	Emission Color	Technolog y	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-S85ATYG	Yellow Green	AllnGaP	20	45	2.0	IN-S85ATYG
IN-S85ATY	Yellow	AllnGaP	20	115	2.0	IN-S85ATY
IN-S85ATA	Amber	AllnGaP	20	80	2.0	IN-S85ATA
IN-S85ATR	Red	AllnGaP	20	140	2.2	IN-S85ATR
IN-S85AT5B	Blue	InGaN	5	80	3.0	IN-S85AT5B
IN-S85ATG	Green	InGaN	20	600	3.2	IN-S85ATG
IN-S85AT5UW	White	InGaN	5	180	3.0	IN-S85AT5UW



Label Specifications



Inolux P/N:

I	N	-	S	8	5	А	T			Х	-	Χ	Х	Х	Х
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color			usto Stan		
	olux MD		S = PCB Type	85A =	· 2.0 x 1	25 x 1.1mm	T = Top Mount	(Blank) = 20mA 5-5mA	(Blank) = Clear U = Diffused	R=630nm A=610nm Y=594nm YG=576nm G=528nm B=473nm W=White					

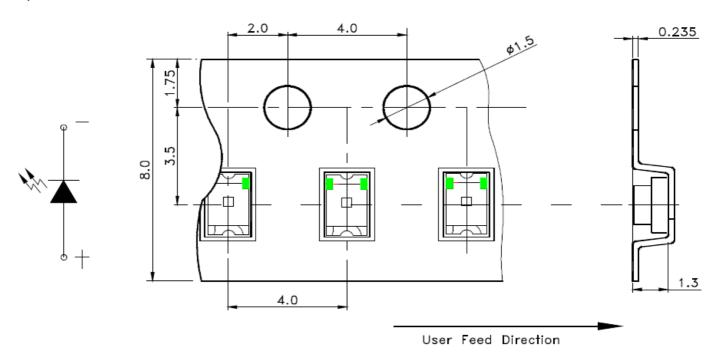
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor /2017	2019 \		Month	Data	Coriol
Tracker		Year (2017	, 2018,)		Month	Date	Serial

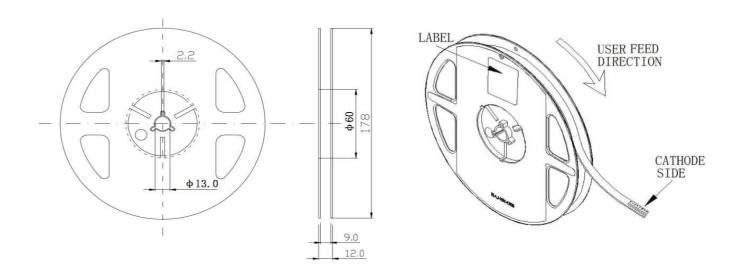


Packaging Information: 4000pcs Per Reel

Tape Dimension

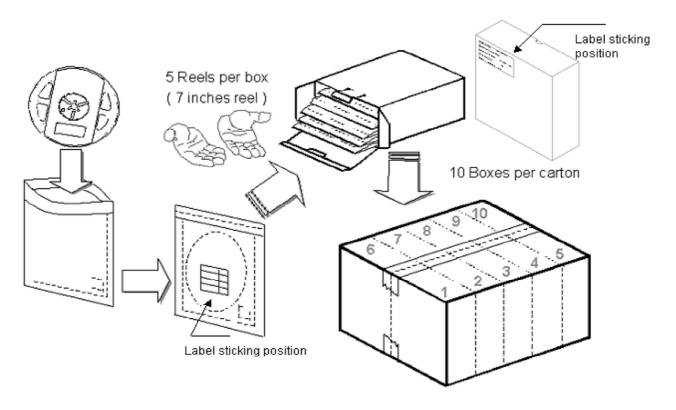


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Othous	<u> </u>	·	

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

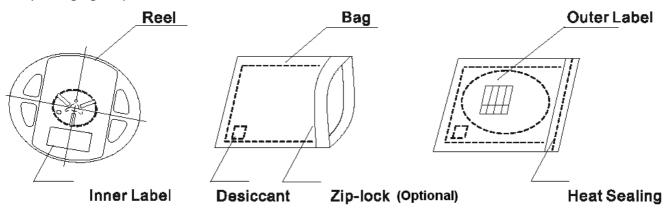


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

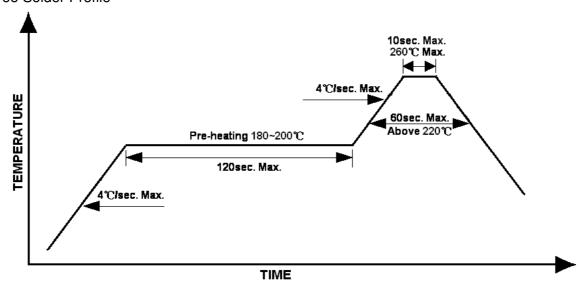
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- · Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



IN-S85AT series Top View SMD LED 0805 PCB Type

Reliability

ltom	Frequency/ lots/ samples/	Standards	Conditions				
Item	failures	Reference					
Precondition	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs				
Precondition	monitoring tests according to JEDEC Level 2		2.) Moisture storage at 85℃/ 60% R.H. for 168hrs				
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155℃/ 24hrs				
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s				
			Tinning: A: 215℃/ 3+1s or B: 260℃/ 10+1s				
		CNS-5067	Dipping soldering terminal only				
Resistance to			Soldering bath temperature				
soldering heat			A: 260+/-5℃; 10+/-1s				
			B: 350+/-10℃; 3+/-0.5s				
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85℃ bakin g for 24hrs				
Operating life test			85℃/ 60%R.H. for 168hrs				
			2.) Tamb25℃; IF=20mA; duration 1000hrs				
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85℃				
high temperature			Humidity: 85% R.H., IF=5mA				
bias			Duration: 1000hrs				
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55℃				
bias			IF=20mA				
Diao			Duration: 1000hrs				
	1Q/ 1/ 40/ 0		Tamb25℃, If=20mA,, Ip=100mA, Duty				
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)				
			Duration 500hrs)				
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C				
Temperature		IEC 68-2-14, Nb	15min				
cycle			Thermal steady within 5 min				
Cycle			300 cycles				
			2 chamber/ Air-to-air type				
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3℃				
storage test			90+5/-10% R.H. for 500hrs				
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10℃ for 500hrs				
storage test							
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5℃ for 500hrs				
storage test							



IN-S85AT series Top View SMD LED 0805 PCB Type

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	02-07-2017
	·		

DISCLAIMER

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.